

# **Maximum Ratings** (@ $T_A = +25$ °C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load. For capacitance load, derate current by 20%.

Characteristic	Symbol	B220/A	B230/A	B240/A	B250/A	B260/A	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	20	30	40	50	60	V
RMS Reverse Voltage	V <sub>R(RMS)</sub>	14	21	28	35	42	V
Average Rectified Output Current	I <sub>O</sub>			2.0			Α
Non-Repetitive Peak Forward Surge Current, 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>	50			А		

# **Thermal Characteristics**

Characteristic		Symbol	Value	Unit
Typical Thermal Resistance, Junction to Lead	SMA SMB	$R_{ heta JL}$	25 20	°C/W
Operating and Storage Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	°C

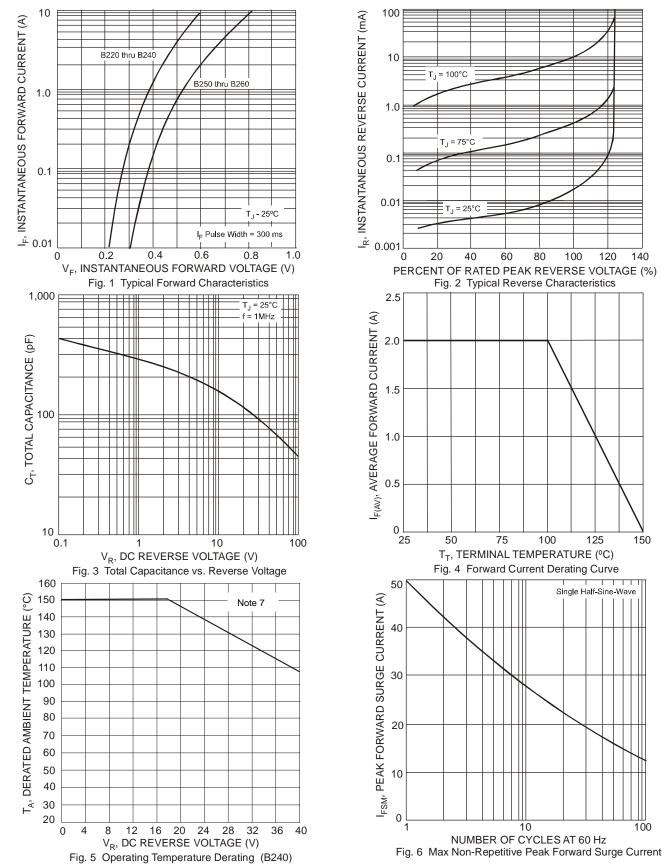
## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Charac	teristic	Symbol	Min	Тур	Max	Unit	Test Condition
Forward Voltage Drop	B220/A, B230/A, B240/A B250/A, B260/A	\/-	_	_	0.50 0.70	V	I <sub>F</sub> = 2.0A, T <sub>A</sub> = +25°C
Leakage Current (Note 6)		I <sub>R</sub>		_	0.5 20	mA	@ Rated $V_R$ , $T_A = +25$ °C @ Rated $V_R$ , $T_A = +100$ °C
Total Capacitance		C <sub>T</sub>		_	200	pF	$V_R = 40V, f = 1MHz$

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Note: 6. Short duration pulse test used to minimize self-heating effect.





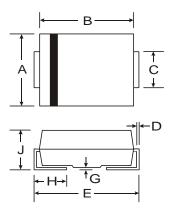
Note: 7. Device mounted on FR-4 PC board with minimum recommended pad layout pattern as per http://www.diodes.com.



# **Package Outline Dimensions**

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

### SMA/SMB



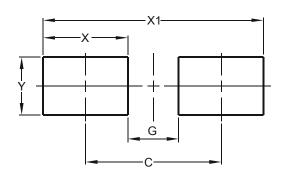
SMA				
Dim	Min	Max		
Α	2.29	2.92		
В	4.00	4.60		
С	1.27	1.63		
D	0.15	0.31		
E	4.80	5.59		
G	0.05	0.20		
Н	0.76	1.52		
J	2.01	2.30		
All Dimensions in mm				

	CMD				
SMB					
Dim	Min	Max			
Α	3.30	3.94			
В	4.06	4.57			
U	1.96	2.21			
D	0.15	0.31			
Е	5.00	5.59			
G	0.05	0.20			
H	0.76	1.52			
J	2.00	2.50			
All Dimensions in mm					

## **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.

### SMA/SMB



SMA		
Dimensions	Value (in mm)	
С	4.00	
G	1.50	
Х	2.50	
X1	6.50	
Υ	1.70	

SMB			
Dimensions	Value (in mm)		
С	4.30		
G	1.80		
Х	2.50		
X1	6.80		
Υ	2.30		

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